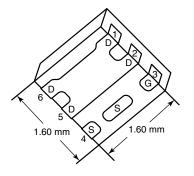


**Vishay Siliconix** 

## P-Channel 20-V (D-S) MOSFET

| PRODUCT SUMMARY     |  |                    |                       |  |  |  |  |  |
|---------------------|--|--------------------|-----------------------|--|--|--|--|--|
| V <sub>DS</sub> (V) | <b>R<sub>DS(on)</sub> (</b> Ω <b>)</b> | I <sub>D</sub> (A) | Q <sub>g</sub> (Typ.) |  |  |  |  |  |
| - 20                | 0.058 at V <sub>GS</sub> = - 4.5 V     | - 9 <sup>a</sup>   |                       |  |  |  |  |  |
|                     | 0.077 at V <sub>GS</sub> = - 2.5 V     | - 9 <sup>a</sup>   | 7.6 nC                |  |  |  |  |  |
|                     | 0.105 at V <sub>GS</sub> = - 1.8 V     | - 5                |                       |  |  |  |  |  |

#### PowerPAK SC-75-6L-Single



## **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- New Thermally Enhanced PowerPAK® SC-75 Package
  - Small Footprint Area
- Low On-Resistance
- 100 % R<sub>g</sub> Tested Typical ESD Performance 2000 V
- Built in ESD Protection with Zener Diode
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

Lot Traceability and Date code

#### **APPLICATIONS**

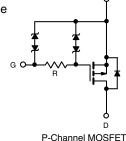
Part # code

- Load Switch for Portable Devices
- Charger Switch for Portable Devices

Marking Code

BLX

• X X X т



**Ordering Information:** SiB433EDK-T1-GE3 (Lead (Pb)-free and Halogen-free)

| Parameter  |   | Symbol                            | Limit  | Unit |  |  |
|--|---|-----------------------------------|--|------|--|--|
| Drain-Source Voltage                               |   | V <sub>DS</sub>                   | - 20   | V    |  |  |
| Gate-Source Voltage                                |   | V <sub>GS</sub>                   | ± 8  | v    |  |  |
| Continuous Drain Current (T <sub>J</sub> = 150 °C) | $T_{C} = 25 °C$ $T_{C} = 70 °C$ $T_{A} = 25 °C$ $T_{A} = 70 °C$ | I <sub>D</sub>                    | - 9 <sup>a</sup><br>- 9 <sup>a</sup><br>- 5.3 <sup>b, c</sup><br>- 4.3 <sup>b, c</sup> | A    |  |  |
| Pulsed Drain Current                               |   | I <sub>DM</sub>                   | - 20   |      |  |  |
| Continuous Source-Drain Diode Current              | T <sub>C</sub> = 25 °C<br>T <sub>A</sub> = 25 °C                | I <sub>S</sub>                    | - 9 <sup>a</sup><br>- 2 <sup>b, c</sup>  | -    |  |  |
| Maximum Power Dissipation                          | $T_{C} = 25 °C$ $T_{C} = 70 °C$ $T_{A} = 25 °C$ $T_{A} = 70 °C$ | P <sub>D</sub>                    | 13<br>8.4<br>2.4 <sup>b, c</sup><br>1.6 <sup>b, c</sup>                                | w    |  |  |
| Operating Junction and Storage Temperature R       | ange  | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 150  |      |  |  |
| Soldering Recommendations (Peak Temperatur         | e) <sup>d, e</sup>  |                                   | 260  |      |  |  |

#### THERMAL RESISTANCE RATINGS

| Parameter                                   | Symbol       | Typical           | Maximum | Unit |      |  |  |  |  |  |
|---|--------------|-------------------|---------|------|------|--|--|--|--|--|
| Maximum Junction-to-Ambient <sup>b, f</sup> | t ≤ 5 s      | R <sub>thJA</sub> | 41      | 51   | °C/W |  |  |  |  |  |
| Maximum Junction-to-Case (Drain)            | Steady State | R <sub>thJC</sub> | 7.5     | 9.5  | 0/11 |  |  |  |  |  |

#### Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 105 °C/W.

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COMPLIANT HALOGEN FREE

Document Number: 65652 For technical support, please contact: pmostechsupport@vishav.com www.vishav.com S12-0979-Rev. B, 30-Apr-12

## Vishay Siliconix



| Parameter                                     | Symbol                                    | Test Conditions  | Min.  | Тур.  | Max.  | Unit           |  |  |
|---|---|--|-------|-------|-------|----------------|--|--|
| Static  |   |  |       |       |       |                |  |  |
| Drain-Source Breakdown Voltage                | $V_{DS}$ $V_{GS} = 0 V, I_D = -250 \mu A$ |  | - 20  |       |       | V              |  |  |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_J$                       | I <sub>D</sub> = - 250 μA  |       | - 13  |       | mV/°C          |  |  |
| V <sub>GS(th)</sub> Temperature Coefficient   | $\Delta V_{GS(th)}/T_J$                   | $I_{\rm D} = -250 \mu \text{A}$  |       | 2.5   |       | mv/ C          |  |  |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>                       | $V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$   | - 0.4 |       | - 1   | V              |  |  |
| Gate-Source Leakage                           | lasa                                      | $V_{DS} = 0 V$ , $V_{GS} = \pm 8 V$  |       | ± 6   |       |                |  |  |
| Gale-Source Leakage                           | I <sub>GSS</sub>                          | $V_{DS} = 0 V, V_{GS} = \pm 4.5 V$   |       |       | ± 0.5 | μA             |  |  |
|   | 1   | $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$   |       |       | - 1   |                |  |  |
| Zero Gate Voltage Drain Current               | I <sub>DSS</sub>                          | $V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C   |       |       | - 10  |                |  |  |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>                        | $V_{DS} \leq$ - 5 V, $V_{GS}$ = - 4.5 V  | - 15  |       |       | Α              |  |  |
|   |   | $V_{GS}$ = - 4.5 V, I <sub>D</sub> = - 3.7 A   |       | 0.047 | 0.058 | Ω              |  |  |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>                       | $V_{GS}$ = - 2.5 V, I <sub>D</sub> = - 3.2 A   |       | 0.064 | 0.077 |                |  |  |
|   |   | V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 1.5 A  |       | 0.085 | 0.105 | 1              |  |  |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>                           | V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 3.7 A   |       | 12    |       | S              |  |  |
| Dynamic <sup>b</sup>                          |   |  |       |       |       |                |  |  |
| •   | Qg  | $V_{DS}$ = - 10 V, $V_{GS}$ = - 8 V, $I_{D}$ = - 5.3 A                                     |       | 14    | 21    | nC             |  |  |
| Total Gate Charge                             |   |  |       | 7.6   | 12    |                |  |  |
| Gate-Source Charge                            | Q <sub>gs</sub>                           | $V_{DS}$ = - 10 V, $V_{GS}$ = - 4.5 V, $I_{D}$ = - 5.3 A                                   |       | 0.8   |       |                |  |  |
| Gate-Drain Charge                             | Q <sub>gd</sub>                           |  |       | 3.1   |       |                |  |  |
| Gate Resistance                               | Rg  | f = 1 MHz  | 0.4   | 2     | 4     | kΩ             |  |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>                        |  |       | 0.2   | 0.3   |                |  |  |
| Rise Time                                     | t <sub>r</sub>                            | $V_{DD}$ = - 10 V, $R_L$ = 2.3 $\Omega$  |       | 1     | 1.5   | -              |  |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>                       | $I_D \cong$ - 4.3 Å, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$                               |       | 4     | 6     |                |  |  |
| Fall Time                                     |   |  |       | 2     | 3     |                |  |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>                        |  |       | 0.09  | 0.14  | - μs<br>-<br>- |  |  |
| Rise Time                                     | t <sub>r</sub>                            | $V_{DD}$ = - 10 V, $R_L$ = 2.3 $\Omega$  |       | 0.4   | 0.6   |                |  |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>                       | $I_D \cong$ - 4.3 A, $V_{GEN}$ = - 8 V, $R_g$ = 1 $\Omega$                                 |       | 5.2   | 7.8   |                |  |  |
| Fall Time                                     | t <sub>f</sub>                            |  |       | 2.3   | 3.5   |                |  |  |
| Drain-Source Body Diode Characterist          | ics                                       |  |       |       |       |                |  |  |
| Continuous Source-Drain Diode Current         | ۱ <sub>S</sub>                            | T <sub>C</sub> = 25 °C   |       |       | - 9   | _              |  |  |
| Pulse Diode Forward Current                   | I <sub>SM</sub>                           |  |       |       | - 20  | A              |  |  |
| Body Diode Voltage                            | V <sub>SD</sub>                           | I <sub>S</sub> = - 4.3 A, V <sub>GS</sub> = 0 V  |       | - 0.8 | - 1.2 | V              |  |  |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>                           |  |       | 30    | 60    | ns             |  |  |
| Body Diode Reverse Recovery Charge            | Q <sub>rr</sub>                           |  |       | 20    | 40    | nC             |  |  |
| Reverse Recovery Fall Time                    | t <sub>a</sub>                            | $I_F = -4.3 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$ |       | 13    |       |                |  |  |
| Reverse Recovery Rise Time                    | t <sub>b</sub>                            |  |       | 17    |       | ns             |  |  |

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

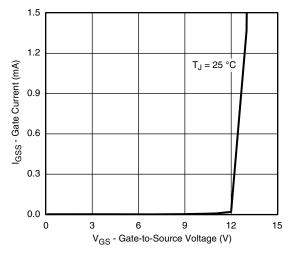
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

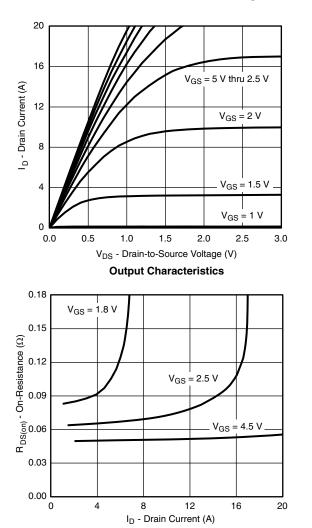


## SiB433EDK Vishay Siliconix

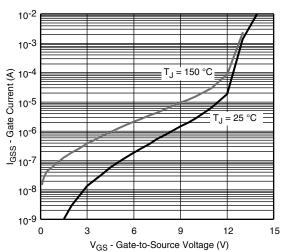
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



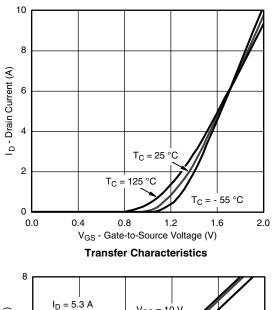


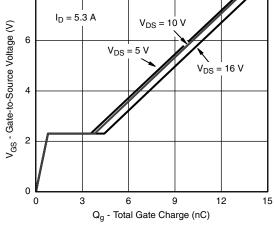


**On-Resistance vs. Drain Current** 



Gate Current vs. Gate-Source Voltage





**Gate Charge** 

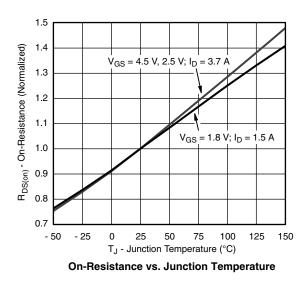
3

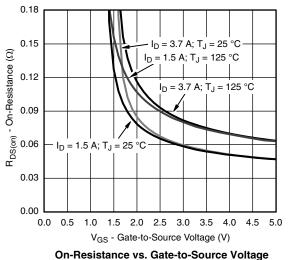
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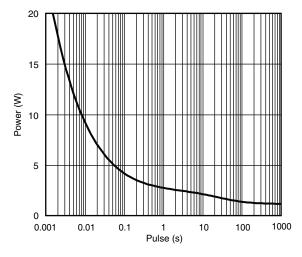


## **Vishay Siliconix**

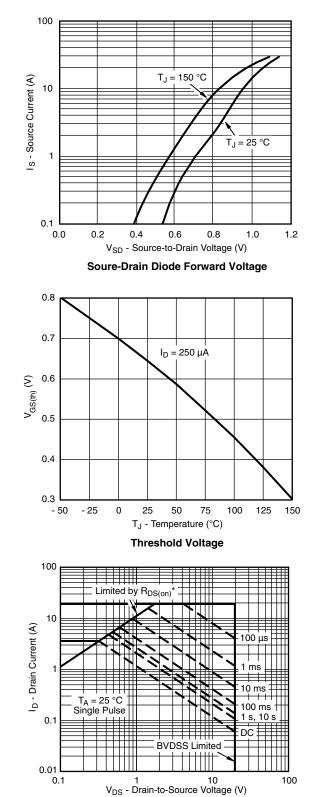
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Single Pulse Power, Junction-to-Ambient



\* V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified Safe Operating Area, Junction-to-Ambient

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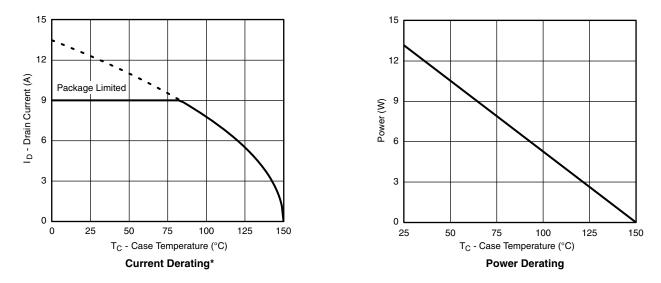
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

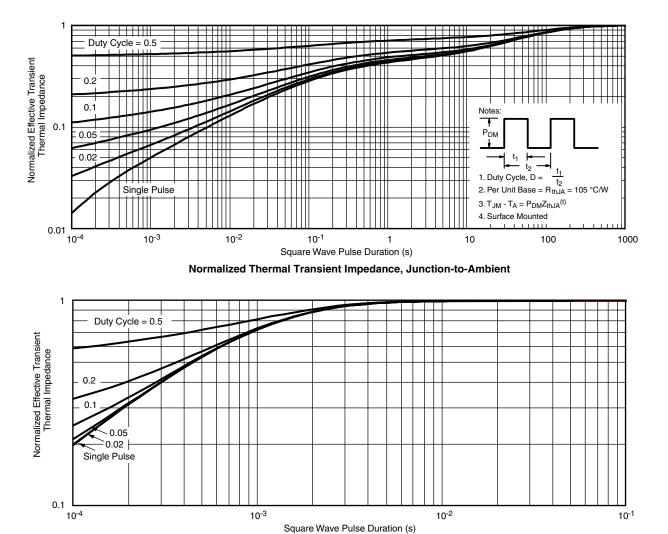


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/ tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?65652">www.vishay.com/ppg?65652</a>.

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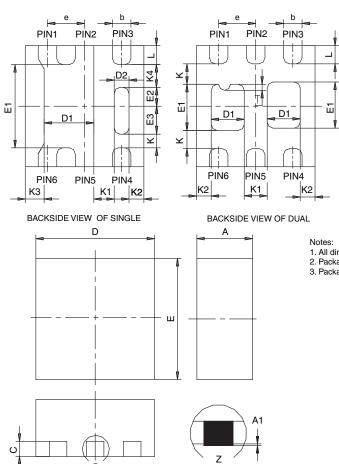
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# Package Information

## Vishay Siliconix





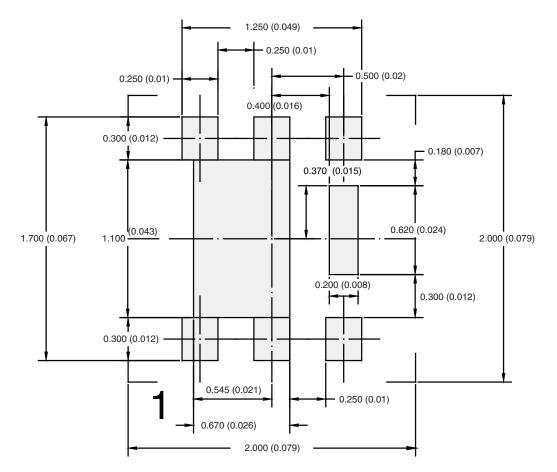
- All dimensions are in millimeters
   Package outline exclusive of mold flash and metal burr
   Package outline inclusive of plating

DETAIL Z

|   | SINGLE PAD          |           |           |                    |           |       | DUAL PAD    |      |           |           |       |       |
|---|---------------------|-----------|-----------|--------------------|-----------|-------|-------------|------|-----------|-----------|-------|-------|
| DIM   | MILLIMETERS         |           |           | INCHES             |           |       | MILLIMETERS |      |           | INCHES    |       |       |
|   | Min                 | Nom       | Max       | Min                | Nom       | Max   | Min         | Nom  | Max       | Min       | Nom   | Max   |
| Α   | 0.675               | 0.75      | 0.80      | 0.027              | 0.030     | 0.032 | 0.675       | 0.75 | 0.80      | 0.027     | 0.030 | 0.032 |
| A1  | 0                   | -         | 0.05      | 0                  | -         | 0.002 | 0           | -    | 0.05      | 0         | -     | 0.002 |
| b   | 0.18                | 0.25      | 0.33      | 0.007              | 0.010     | 0.013 | 0.18        | 0.25 | 0.33      | 0.007     | 0.010 | 0.013 |
| С   | 0.15                | 0.20      | 0.25      | 0.006              | 0.008     | 0.010 | 0.15        | 0.20 | 0.25      | 0.006     | 0.008 | 0.010 |
| D   | 1.53                | 1.60      | 1.70      | 0.060              | 0.063     | 0.067 | 1.53        | 1.60 | 1.70      | 0.060     | 0.063 | 0.067 |
| D1  | 0.57                | 0.67      | 0.77      | 0.022              | 0.026     | 0.030 | 0.34        | 0.44 | 0.54      | 0.013     | 0.017 | 0.021 |
| D2  | 0.10                | 0.20      | 0.30      | 0.004              | 0.008     | 0.012 |             |      |           |           |       |       |
| Е   | 1.53                | 1.60      | 1.70      | 0.060              | 0.063     | 0.067 | 1.53        | 1.60 | 1.70      | 0.060     | 0.063 | 0.067 |
| E1  | 1.00                | 1.10      | 1.20      | 0.039              | 0.043     | 0.047 | 0.51        | 0.61 | 0.71      | 0.020     | 0.024 | 0.028 |
| E2  | 0.20                | 0.25      | 0.30      | 0.008              | 0.010     | 0.012 |             |      |           |           |       |       |
| E3  | 0.32                | 0.37      | 0.42      | 0.013              | 0.015     | 0.017 |             |      |           |           |       |       |
| е   |                     | 0.50 BSC  |           |                    | 0.020 BSC |       | 0.50 BSC    |      |           | 0.020 BSC |       |       |
| К   |                     | 0.180 TYP |           |                    | 0.007 TYP |       | 0.245 TYP   |      | 0.010 TYP |           |       |       |
| K1  |                     | 0.275 TYP |           |                    | 0.011 TYP |       | 0.320 TYP   |      |           | 0.013 TYP |       |       |
| K2  | 0.200 TYP 0.008 TYP |           |           | 0.200 BSC 0.008 TY |           |       | 0.008 TYP   |      |           |           |       |       |
| K3  | 0.255 TYP 0.010 TYP |           |           |                    |           |       |             |      |           |           |       |       |
| K4  | 0.300 TYP           |           | 0.012 TYP |                    |           |       |             |      |           |           |       |       |
| L   | 0.15                | 0.25      | 0.35      | 0.006              | 0.010     | 0.014 | 0.15        | 0.25 | 0.35      | 0.006     | 0.010 | 0.014 |
| Т   |                     |           |           |                    |           |       | 0.03        | 0.08 | 0.13      | 0.001     | 0.003 | 0.005 |
| ECN: C-07431 – Rev. C, 06-Aug-07<br>DWG: 5935 |                     |           |           |                    |           |       |             |      |           |           |       |       |



## RECOMMENDED PAD LAYOUT FOR PowerPAK<sup>®</sup> SC75-6L Single



Dimensions in mm/(Inches)

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Vishay

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